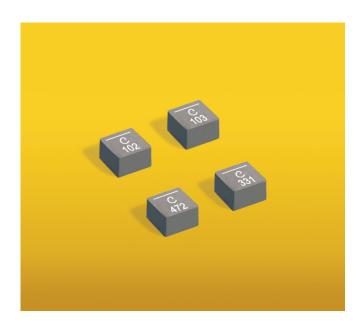
# High Reliability Power Inductors ST449PYA



- High current and very low DCR
- Soft saturation makes them ideal for VRM/VRD applications.

Core material Composite

Terminations Tin-silver (96.5/3.5) over copper.

**Weight** 0.26 – 0.28 g

Ambient temperature  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  with Irms current

Maximum part temperature +165°C (ambient + temp rise).

**Storage temperature** Component: -55°C to +165°C.

Tape and reel packaging: -55°C to +80°C

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at  $<30^{\circ}$ C / 85% relative humidity)

**Enhanced crush-resistant packaging** 500 per 7" reel; Plastic tape: 12 mm wide, 0.23 mm thick, 8 mm pocket spacing, 3.25 mm pocket depth

Part number¹	Inductance <sup>2</sup> ±20% (µH)	DCR (mOhms)3		SRF (MHz) <sup>4</sup>		Isat⁵	Irms (A) <sup>6</sup>	
		typ	max	min	typ	(A)	20°C rise	40°C rise
ST449PYA221MLZ	0.22	2.96	3.26	169	211	21.0	10.5	12.9
ST449PYA361MLZ	0.36	3.86	4.25	148	185	15.8	9.5	12.6
ST449PYA501MLZ	0.50	4.77	5.25	96	120	13.4	8.3	11.6
ST449PYA681MLZ	0.68	6.39	7.03	91	114	12.4	7.4	10.5
ST449PYA102MLZ	1.0	8.89	9.78	72	90	9.7	5.6	7.4
ST449PYA152MLZ	1.5	15.1	16.6	49	61	7.4	5.1	6.6
ST449PYA222MLZ	2.2	20.1	22.1	42	53	6.1	4.4	5.9
ST449PYA332MLZ	3.3	26.1	28.6	34	43	5.9	3.8	5.0
ST449PYA472MLZ	4.7	40.1	44.1	29	36	4.6	2.9	3.8
ST449PYA682MLZ	6.8	67.4	74.1	23	29	3.6	2.3	2.9

1. When ordering, please specify termination and screening codes:

#### ST449PYA682MLZ

**Termination:** L = Tin-silver (96.5/3.5) over copper. **Special order:** S = Tin-lead (63/37).

Screening:

- **Z** = Unscreened
- Y = Unscreened (SLDC Option A)
- **W**= Unscreened (SLDC Option B)
- H= Coilcraft CP-SA-10001 Group A
- G= Coilcraft CP-SA-10001 Group A (SLDC Option A)
- D = Coilcraft CP-SA-10001 Group A (SLDC Option B)
- · Screening performed to the document's latest revision.
- · Custom testing also available.
- Country of origin restrictions available; prefix option G.
- 2. Inductance tested at 100 kHz, 0.1 Vrms, 0 Adc.
- 3. DCR measured on a micro-ohmmeter.
- 4. SRF measured using Agilent/HP 4395A or equivalent.
- 5. DC current at which the inductance drops the specified amount from its value without current.
- Current that causes the specified temperature rise from 25°C ambient. This information is for reference only and does not represent absolute maximum ratings.
- 7. Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.

### Irms Testing

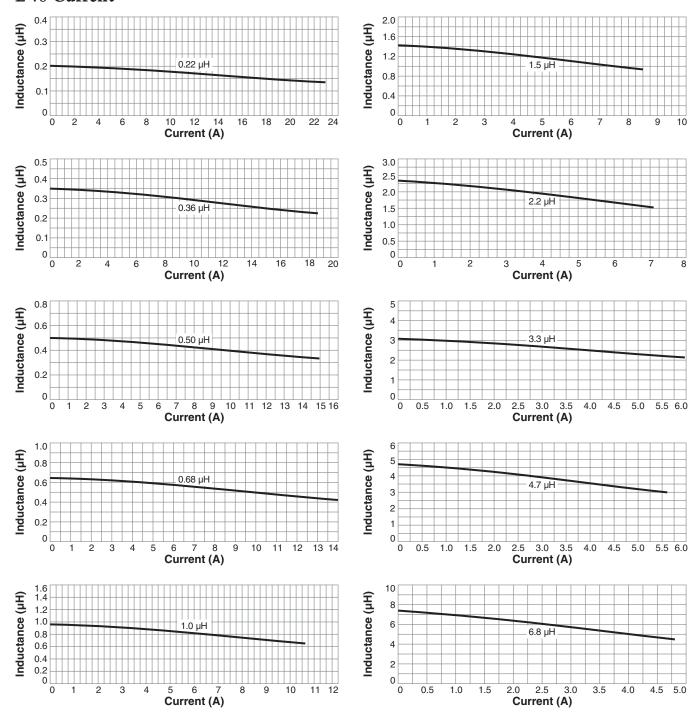
Irms testing was performed on a 0.060" thick pcb with 4 oz. copper traces optimized to minimize additional temperature rise.

Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions.



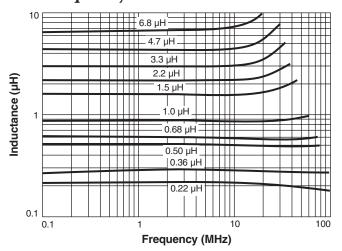
## **ST449PYA Series**

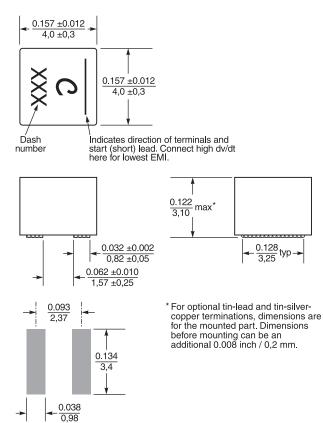
#### L vs Current



## **ST449PYA Series**

#### L vs Frequency





Suggested Land Pattern